

Getting started with the X-NUCLEO-GNSS2A1 expansion board based on the Teseo-VIC3DA dead-reckoning GNSS module for STM32 Nucleo

Introduction

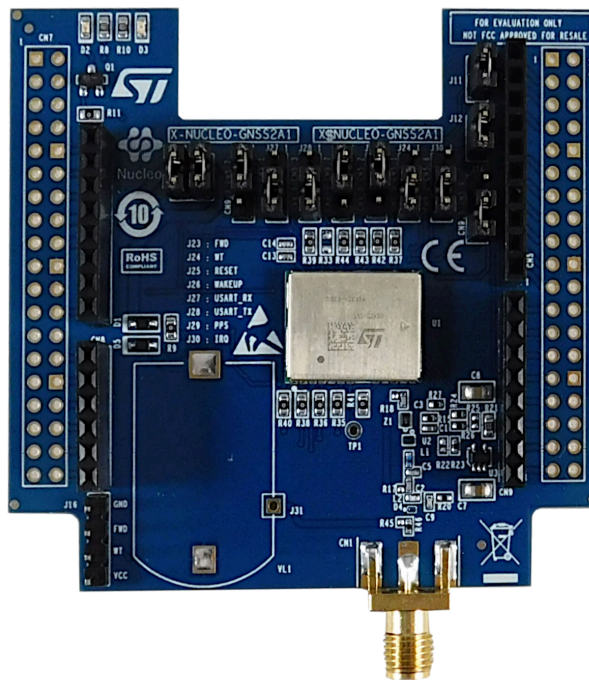
The **X-NUCLEO-GNSS2A1** expansion board is based on the **Teseo-VIC3DA** tiny GNSS module. It represents an affordable, easy-to-use, global navigation satellite system (GNSS) module, which embeds a TeseoIII single die standalone positioning receiver IC, usable in different configurations in your **STM32 Nucleo** project.

The **Teseo-VIC3DA** is a compact (16.0 x 12.2 mm) module that provides superior accuracy thanks to the on-board temperature compensated crystal oscillator (TCXO) and a reduced time-to-first fix (TTFF) with its dedicated real-time clock (RTC) oscillator.

The **Teseo-VIC3DA** module runs the GNSS firmware (**X-CUBE-GNSS1**) to perform all the GNSS operations including acquisition, tracking, navigation, and data output without any external memory support.

The **X-NUCLEO-GNSS2A1** expansion board is compatible with the Arduino UNO R3 connector and the ST morpho connector. It can be plugged to an **STM32 Nucleo** development board and stacked with additional **STM32 Nucleo** expansion boards.

Figure 1. X-NUCLEO-GNSS2A1 expansion board



1 Getting started

1.1 Board overview

The [X-NUCLEO-GNSS2A1](#) expansion board for [STM32 Nucleo](#) is a GNSS multiconstellation receiver with dead-reckoning that covers a wide range of applications where geo-location is required.

The key features are:

- Operating supply voltage: 3.3 V
- Ambient temperature: -40/+85°C
- Sensitivity: -163 dBm (tracking mode)
- Interfaces:
 - a UART port
 - an I²C port
 - configurable digital I/O time pulse
 - EXTINT input for wake-up
- NMEA protocol
- Assisted GNSS:
 - autonomous AGNSS
 - real-time, server-based
- Simultaneous multiconstellation:
 - GPS
 - Galileo
 - Glonass
 - BeiDou
 - QZSS
- Compatible with [STM32 Nucleo](#) development boards
- Compatible with the Arduino UNO R3 connector
- [Teseo-VIC3DA](#) dead-reckoning automotive firmware
- Provision of FWD and WHEELTICK signals
- Automotive GNSS and 6-axis inertial sensor
- LNA and SAW filters on the RF path
- SMA female antenna connector
- RoHS and WEEE compliant

1.2 Hardware and software requirements

The X-NUCLEO-GNSS2A1 must be plugged onto an STM32 Nucleo development board through the Arduino UNO R3 connectors, as shown in the figure below.

Figure 2. X-NUCLEO-GNSS2A1 expansion board connected to an STM32 Nucleo development board



The X-NUCLEO-GNSS2A1 can be connected to any STM32 Nucleo development board, even though complete testing has been performed on the NUCLEO-F401RE board.

To use the STM32 Nucleo development boards with the X-NUCLEO-GNSS2A1 expansion board, the following software and hardware specifications are required:

- a PC with Microsoft Windows® 10 to install the software package (X-CUBE-GNSS1);
- an STM32 Nucleo development board (NUCLEO-L053R8 or NUCLEO-F401RE);
- a type A to mini-B USB cable to connect the STM32 Nucleo to the PC;
- the X-CUBE-GNSS1 software package;
- TESEO-SUITE.

The installation of the X-CUBE-GNSS1 and the TESEO-SUITE graphical user interface utility on the user PC requires:

- 128 MB of RAM;
- 40 MB of hard disk space.

1.3 Board setup

To set up the X-NUCLEO-GNSS2A1 expansion board, follow the procedure below.

Step 1. Check the jumper position shown below:

Table 1. X-NUCLEO-GNSS2A1 expansion board - jumper 1 default settings

Signal	Jumper	Configuration
I ² C-SCL	J11	Closed
I ² C-SDA	J12	Closed
VCC-VCC_IO	J14	Closed
V14Bat	J15	Closed
SYS_FWD	J23	1-2
SYS_WHEELTICK	J24	2-3
SYS_RESETn	J25	1-2
SYS_WAKEUP	J26	2-3
UART-RX	J27	2-3
UART-TX	J28	2-3
SYS_PPS	J29	1-2
SYS_IRQ	J30	2-3

Step 2. Connect the X-NUCLEO-GNSS2A1 to the STM32 Nucleo development board.

Step 3. Power the STM32 Nucleo development board using the type A mini-B USB cable.

Step 4. Program the STM32 Nucleo development board using the firmware example provided.

Step 5. Reset the MCU via the STM32 Nucleo development board [**reset**] button.
The evaluation kit is ready-to-use.

2 Hardware description

2.1 X-NUCLEO-GNSS2A1 expansion board for STM32 Nucleo

The X-NUCLEO-GNSS2A1 allows testing the Teseo-VIC3DA GNSS module functionality via the firmware package contained in the X-CUBE-GNSS1 software.

Important: Program the microcontroller on the STM32 Nucleo development board.

The Teseo-VIC3DA module and the STM32 Nucleo development board communicate through the expansion board connectors (CN5, CN6, CN8, and CN9) as listed in the tables below.

Table 2. Interconnection between STM32 Nucleo development board and X-NUCLEO-GNSS2A1 expansion board (left-side connectors)

STM32 Nucleo pins	X-NUCLEO-GNSS2A1		
	CN6 (power)		CN8 (analog)
	Pin	Signal	
NC	X		
IOREF	2	3V3	
RESET	3		
3V3	4	3V3	
5V	5		
GND	6	GND	
GND	7	GND	
VIN	8		
A0			1
A1			2
A2			3
A3			4
A4			5
A5			6

Table 3. Interconnection between STM32 Nucleo development board and X-NUCLEO-GNSS2A1 expansion board (right-side connectors)

STM32 Nucleo pins	X-NUCLEO-GNSS2A1			
	CN5 (digital)		CN9 (digital)	
	Pin	Signal	Pin	Signal
D15	10	SCL2		
D14	9	SDA2		
AREF	8			
GND	7	GND		
D13	6	WAKE_UP		
D12	5			
D11	4			
D10	3			

STM32 Nucleo pins	X-NUCLEO-GNSS2A1			
	CN5 (digital)		CN9 (digital)	
	Pin	Signal	Pin	Signal
D9	2	RESET		
D8	1	RX0		
D7			8	RESET
D6			7	PPS
D5			6	
D4			5	WAKE_UP
D3			4	
D2			3	TX0/PPS
D1			2	RX
D0			1	TX

2.2 Teseo-VIC3DA module

The X-NUCLEO-GNSS2A1 expansion board embeds the Teseo-VIC3DA automotive GNSS dead-reckoning module with 6-axis IMU.

The Teseo-VIC3DA is an easy-to-use global navigation satellite system (GNSS) standalone module. It embeds the TeseoIII single-die standalone positioning receiver IC, which works simultaneously on multiple constellations (GPS/Galileo/Glonass/BeiDou/QZSS).

Table 4. Teseo-VIC3DA details

Feature	Description
Sales type	Teseo-VIC3DA
Package	LLC 24 pins (16.0 mm x 12.2 mm)
Operating voltage	3.3 V

2.3 GNSS antenna

The GNSS antenna (manufacturer INPAQ, part number B3G02G-S3-XX-A) is attached to the board through a SMA connector (with its trademark and model).

Important: The antenna provided by the manufacturer can be replaced only with an identical one.

2.4 UART, I²C, and GPIO connection options

The Teseo-VIC3DA module embedded in the X-NUCLEO-GNSS2A1 expansion board can be used to work with the board in different configurations when different expansion boards are used and a conflict of signals occurs.

Table 5. X-NUCLEO-GNSS2A1 expansion board: Teseo-VIC3DA interface with the STM32 Nucleo development board

Signal	Pins	STM32 Nucleo (optional connections)
I ² C-SCL	d15	-
I ² C-SDA	d14	-
Wakeup	d13	d4
Reset	d7	d9
PPS	d6	d2
UART-RX	d8	d1
UART-TX	d2	d0

For the optional connections, modify the firmware according to the STM32 resources to be used.

2.5 Current measurement

To monitor the [Teseo-VIC3DA](#) module power consumption, insert an ammeter probe between J14 pin (VCC) and J15 pin (VBAT).

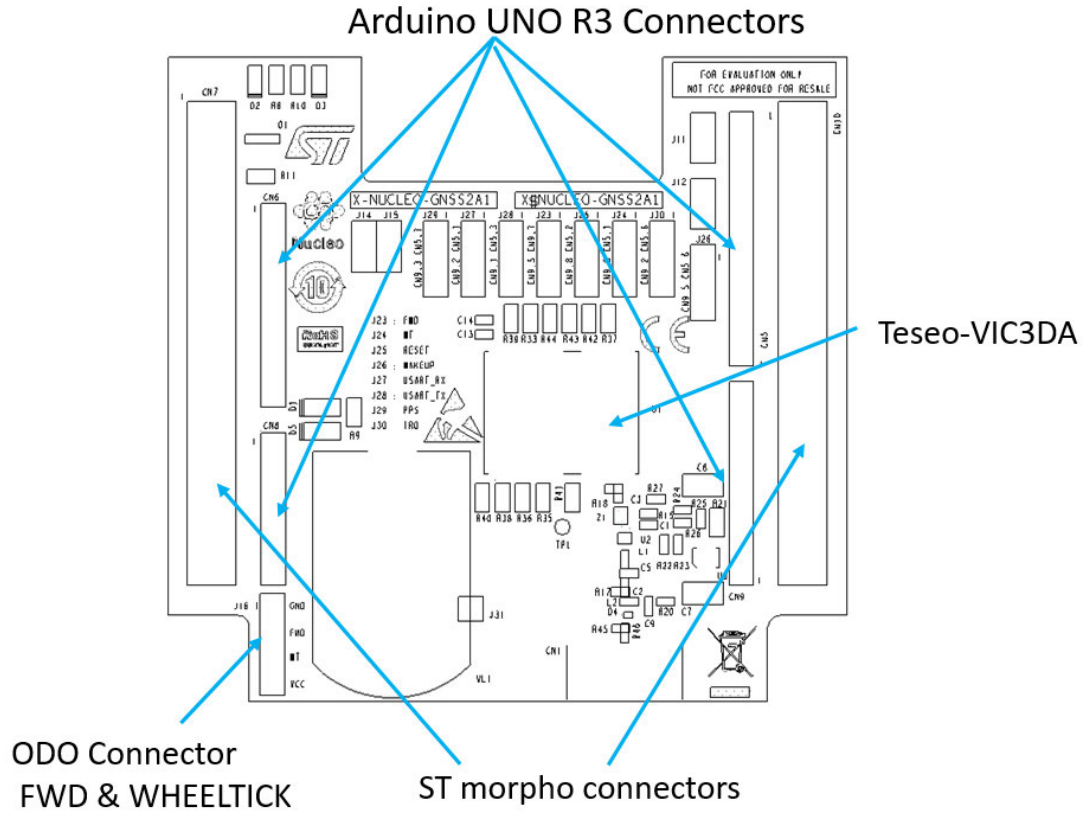
As the [Teseo-VIC3DA](#) power consumption is very low during most of its operating time, an accurate instrument in the range of few μA is required.

2.6 ODO connector

The ODO connector on the [X-NUCLEO-GNSS2A1](#) exposes two input signals for the [Teseo-VIC3DA](#), which embeds the TESEO dead reckoning. These two signals are specific to dead-reckoning applications and provide the odometer information using the pins FWD (pin2) and WHEELTICK (pin3).

2.7 X-NUCLEO-GNSS2A1 expansion board component placement

Figure 3. X-NUCLEO-GNSS2A1 expansion board component placement details



3 Schematic diagrams

Figure 4. X-NUCLEO-GNSS2A1 circuit schematic (1 of 3)

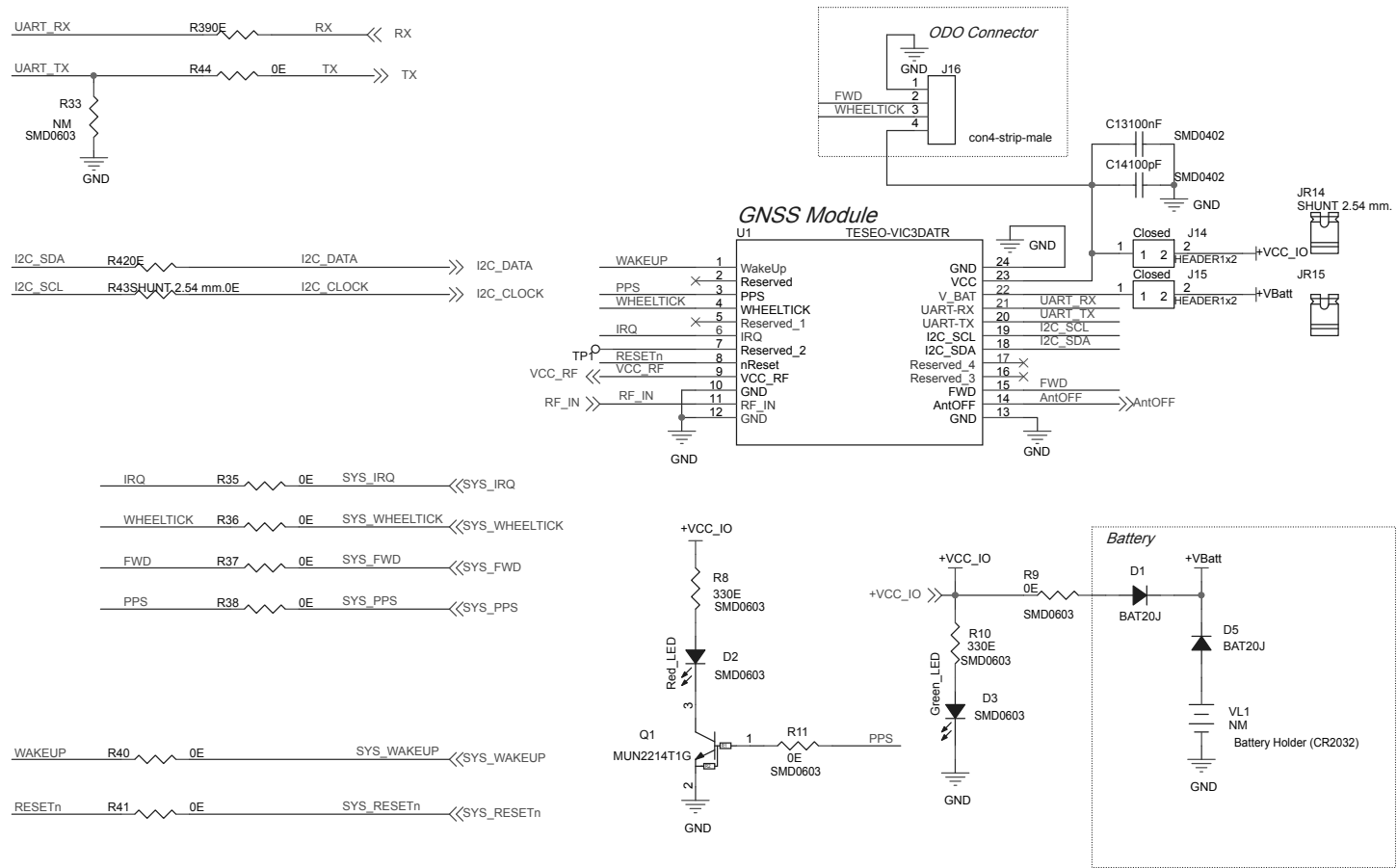


Figure 5. X-NUCLEO-GNSS2A1 circuit schematic (2 of 3)

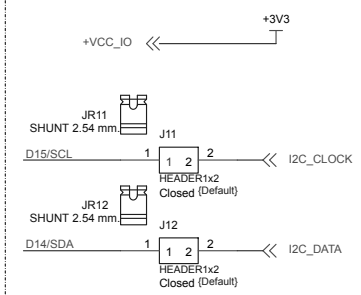
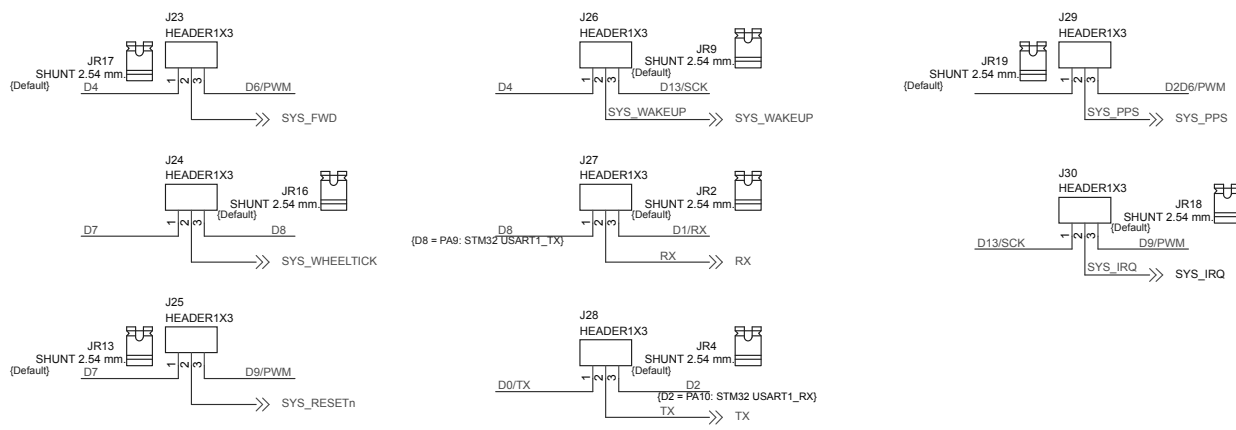
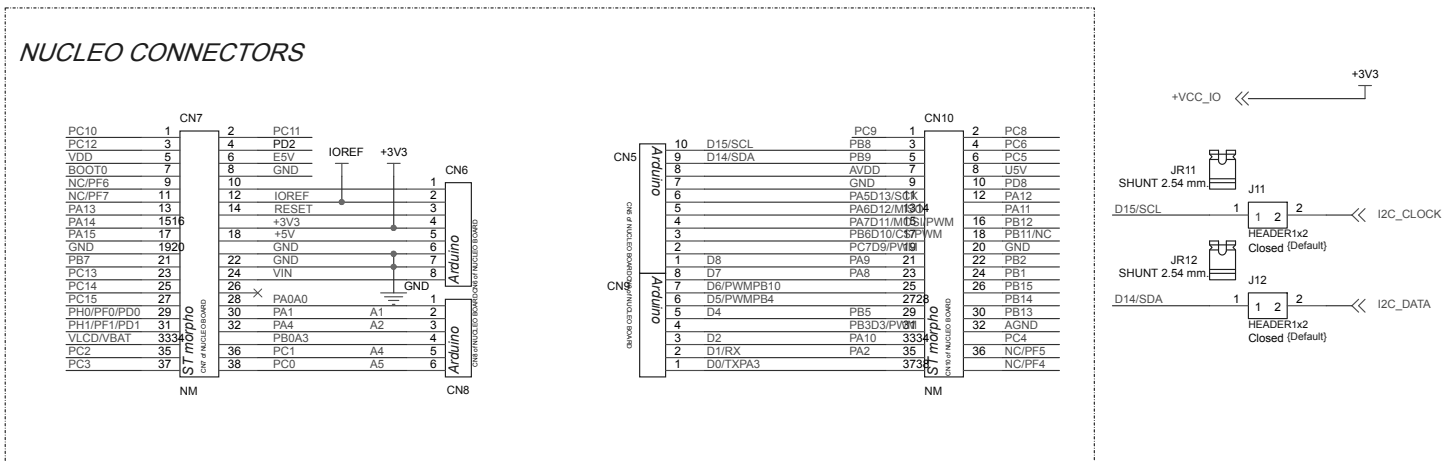
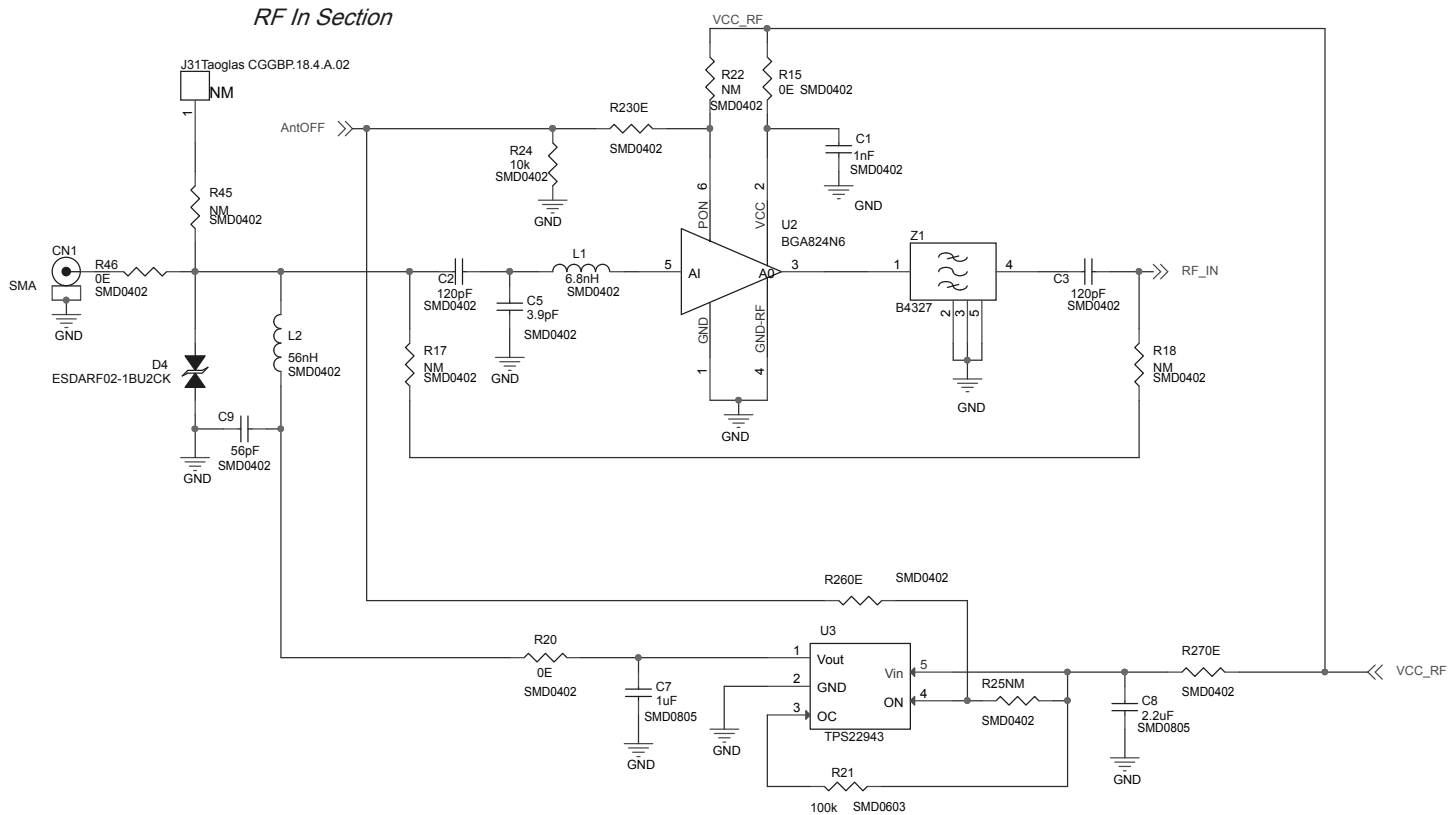


Figure 6. X-NUCLEO-GNSS2A1 circuit schematic (3 of 3)



4 Bill of materials

Table 6. X-NUCLEO-GNSS2A1 bill of materials

Item	Q.ty	Ref.	Value	Description	Manufacturer	Order code
1	1	CN1	SMA, COAX_SMA_ED GE	SMA jack	Molex	73251-1150
2	1	CN5	ARDUINO_10x1, TH	Elevated socket	4UCONN	15286
3	2	CN6, CN9	ARDUINO_8x1, TH	Elevated sockets	4UCONN	15284
4	0	CN7,CN10	ST_MORPHO_19 x2, TH	Elevated sockets (not mounted)	4UCONN	8413
5	1	CN8	ARDUINO_6x1, TH	Elevated socket	4UCONN	15282
6	1	C1	1 nF, SMD 0402, 16 V, X7R	Chip capacitor	Murata	GRM155R71H102KA01 D
7	2	C2,C3	120 pF, SMD 0402, 16 V, NP0	Chip capacitors	Murata	GRM1555C1H121JA01 D
8	1	C5	3.9 pF, SMD 0402, 16 V, NP0	Chip capacitor	Murata	GRM1555C1H3R9WA01 D
9	1	C7	1 μF, SMD 0805, 16 V, X7R	Chip capacitor	Taiyo Yuden	EMK212B7105KGHT
10	1	C8	2.2 μF, SMD0805, 16 V, X7R	Chip capacitor	Taiyo Yuden	EMK212B7225KGHT
11	1	C9	56 pF, SMD 0402, 16 V, X7R	Chip capacitor	Murata	GRM1555C1H560JA01 D
12	1	C13	100 nF, SMD 0402, 16 V, X7R	Chip capacitor	Murata	GRM155R71C104KA88 D
13	1	C14	100 pF, SMD 0402, 16 V, COG	Chip capacitor	Murata	GRM1555C1H101JA01 D
14	2	D1, D5	BAT20JFILM, SOD323	23 V, 1 A general purpose signal Schottky diodes	ST	BAT20JFILM
15	1	D2	Red_LED, SMD 0603	Diode LED	Lite-On	LTST-C193KRKT-5A
16	1	D3	Green_LED, SMD 0603	Diode LED	Lite-On	LTST-C191KGKT
17	1	D4	ESDARF02-1BU2 CK, ST0201	Single line bidirectional ESD protection for high-speed interfaces	ST	ESDARF02-1BU2CK
18	12	JR2, JR4, JR9, JR11, JR12, JR13, JR14, JR15, JR16, JR17, JR18, JR19	2.54 mm, TH, 3 A max.	Jumpers	TE Connectivity/AMP	1-382811-6

Item	Q.ty	Ref.	Value	Description	Manufacturer	Order code
19	4	J11, J12, J14, J15	HEADER1x2, TH, 2.54 mm, 2-pin, single row	Headers	Würth Elektronik	61300211121
20	1	J16	HEADER1x4, TH, 2.54 mm, 4-pin, single row	Header	Würth Elektronik	61300411121
21	8	J23, J24, J25, J26, J27, J28, J29, J30	HEADER1x3, TH, 2.54 mm, 3-pin, single row	Headers	Würth Elektronik	61300311121
22	1	J31	Taoglas CGGBP.18.4.A.02 , 18 mm x 18 mm x 4 mm (pin mount)	RF antenna (not mounted)	Taoglas	CGGBP.18.4.A.02
23	1	L1	6.8 nH, SMD 0402, 0.7 A, ± 0.02 %	SMD inductor	Murata	LQW15AN6N8G00D
24	1	L2	5 6nH, SMD 0402, 0.2 A, ± 0.05 %	SMD inductor	Würth Elektronik	744784156A
25	1	Q1	MUN2214T1G, SC-59	NPN digital transistor	ON Semiconductor	MUN2214T1G
26	2	R8, R10	330E, SMD 0603, ± 0.01 %	Chip resistors	Stackpole Electronics Inc	RMCF0603FT330RTR-ND
27	12	R9, R11, R35, R36, R37, R38, R39, R40, R41, R42, R43, R44	0E, SMD 0603, ± 0.01 %	Chip resistors	Stackpole Electronics Inc	RMCF0603ZT0R00
28	6	R15, R20, R23, R26, R27, R46	0E, SMD 0402, ± 0.01 %	Chip resistors	Stackpole Electronics Inc	RMCF0402ZT0R00
29	1	R21	100 k, SMD 0603, ± 0.01 %	Chip resistor	Yageo	AF0603FR-07100KL
30	1	R24	10 k, SMD0402, ± 0.01 %	Chip resistor	Yageo	RE0402FRE0710KL
31	0	R17, R18, R22, R25, R45	0E, SMD0402, 0.01 %,	Chip resistors (not mounted)	Stackpole Electronics Inc	RMCF0402ZT0R00
32	0	R33	0E, SMD 0603, ± 0.01 %	Chip resistor (not mounted)	Stackpole Electronics Inc	RMCF0603ZT0R00
33	1	TP1	TP, tp_60f	Test point	Keystone Electronics	5117 (or 5000 or 5001)
34	1	U1	TESEO-VIC3DATR, LCC 24-pin package	Automotive GNSS dead-reckoning module with 6-axis IMU	ST	TESEO-VIC3DATR
35	1	U2	BGA824N6, TSNP-6-2	Low noise amplifier for GNSS	Infineon	BGA824N6E6327XTSA1
36	1	U3	TPS22943, SC70	IC load switch	Texas Instruments	TPS22943DCKR
37	0	VL1	CR2032, HOLDER_CR2032_S8421-45R	Coin battery holder (not mounted)	Harwin Inc.	S8421-45R

Item	Q.ty	Ref.	Value	Description	Manufacturer	Order code
38	1	Z1	B4327, QCS5P	Saw RF filter	TDK	B39162B4327P810
39	1	-	B3G02G-S3-XX-A	GPS/GLONASS/ Beidou antenna	INPAQ	B3G02G-S3-XX-A

5 Board versions

Table 7. X-NUCLEO-GNSS2A1 versions

PCB version	Schematic diagrams	Bill of materials
X\$NUCLEO-GNSS2A1 ⁽¹⁾	X\$NUCLEO-GNSS2A1 schematic diagrams	X\$NUCLEO-GNSS2A1 bill of materials

1. This code identifies the X-NUCLEO-GNSS2A1 expansion board first version. It is printed on the board PCB.

6 Regulatory compliance information

Formal Notice Required by the U.S. Federal Communications Commission

FCC NOTICE

This kit is designed to allow:

- (1) Product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and
- (2) Software developers to write software applications for use with the end product.

This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter 3.1.2.

Formal Product Notice Required by Industry Canada Innovation, Science and Economic Development

Canada compliance:

For evaluation purposes only. This kit generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to Industry Canada (IC) rules.

À des fins d'évaluation uniquement. Ce kit génère, utilise et peut émettre de l'énergie radiofréquence et n'a pas été testé pour sa conformité aux limites des appareils informatiques conformément aux règles d'Industrie Canada (IC).

Formal product notice required by EU

The X-NUCLEO-GNSS2A1 is in conformity with the essential requirements of the Directive 2014/53/EU (RED) and of the Directive 2015/863/EU (RoHS). Harmonized standards applied are listed in the EU Declaration of Conformity.

Revision history

Table 8. Document revision history

Date	Revision	Changes
25-Jul-2022	1	Initial release.

Contents

1	Getting started	2
1.1	Board overview	2
1.2	Hardware and software requirements	3
1.3	Board setup	4
2	Hardware description	5
2.1	X-NUCLEO-GNSS2A1 expansion board for STM32 Nucleo	5
2.2	Teseo-VIC3DA module	6
2.3	GNSS antenna	6
2.4	UART, I ² C, and GPIO connection options	6
2.5	Current measurement	7
2.6	ODO connector	7
2.7	X-NUCLEO-GNSS2A1 expansion board component placement	8
3	Schematic diagrams	9
4	Bill of materials	12
5	Board versions	15
6	Regulatory compliance information	16
	Revision history	17
	List of tables	19
	List of figures	20

List of tables

Table 1.	X-NUCLEO-GNSS2A1 expansion board - jumper 1 default settings	4
Table 2.	Interconnection between STM32 Nucleo development board and X-NUCLEO-GNSS2A1 expansion board (left-side connectors)	5
Table 3.	Interconnection between STM32 Nucleo development board and X-NUCLEO-GNSS2A1 expansion board (right-side connectors)	5
Table 4.	Teseo-VIC3DA details	6
Table 5.	X-NUCLEO-GNSS2A1 expansion board: Teseo-VIC3DA interface with the STM32 Nucleo development board . . .	7
Table 6.	X-NUCLEO-GNSS2A1 bill of materials	12
Table 7.	X-NUCLEO-GNSS2A1 versions	15
Table 8.	Document revision history	17

List of figures

Figure 1.	X-NUCLEO-GNSS2A1 expansion board	1
Figure 2.	X-NUCLEO-GNSS2A1 expansion board connected to an STM32 Nucleo development board.	3
Figure 3.	X-NUCLEO-GNSS2A1 expansion board component placement details	8
Figure 4.	X-NUCLEO-GNSS2A1 circuit schematic (1 of 3).	9
Figure 5.	X-NUCLEO-GNSS2A1 circuit schematic (2 of 3).	10
Figure 6.	X-NUCLEO-GNSS2A1 circuit schematic (3 of 3).	11

IMPORTANT NOTICE – READ CAREFULLY

STMicroelectronics NV and its subsidiaries (“ST”) reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST’s terms and conditions of sale in place at the time of order acknowledgment.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of purchasers’ products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. For additional information about ST trademarks, refer to www.st.com/trademarks. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2022 STMicroelectronics – All rights reserved